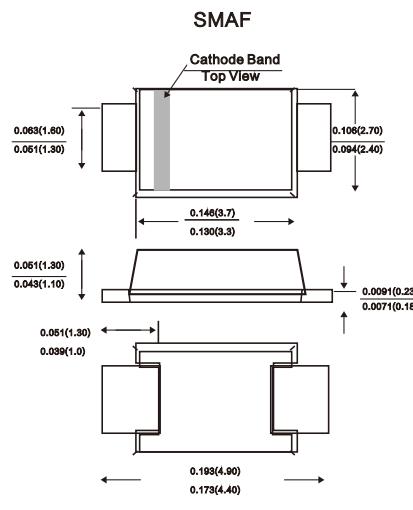


**FEATURES**

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz



Dimensions in inches and (millimeters)

**Absolute Maximum Ratings and Characteristics**

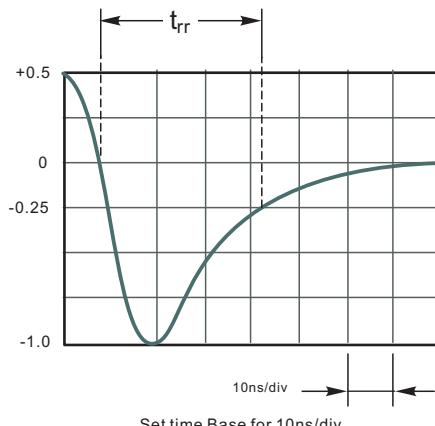
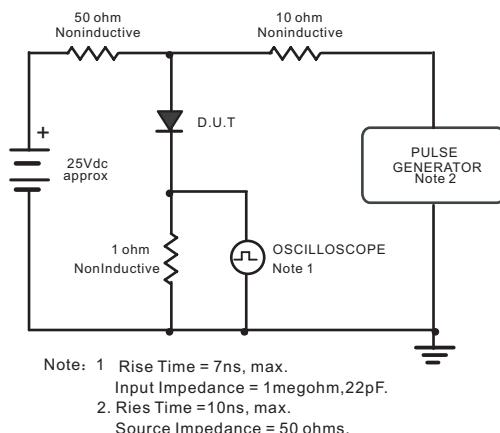
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Parameter	Symbols	ES1AF	ES1BF	ES1CF	ES1DF	ES1EF	ES1GF	ES1JF	Units		
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	150	200	300	400	600	V		
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	210	280	420	V		
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	300	400	600	V		
Maximum Average Forward Rectified Current at T <sub>c</sub> = 125 °C	I <sub>F(AV)</sub>	1						A			
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I <sub>FSM</sub>	30						A			
Maximum Forward Voltage at 1 A	V <sub>F</sub>	1			1.25		1.68	V			
Maximum DC Reverse Current T <sub>a</sub> = 25 °C at Rated DC Blocking Voltage T <sub>a</sub> = 125 °C	I <sub>R</sub>	5 100						μA			
Typical Junction Capacitance at V <sub>R</sub> = 4 V, f = 1 MHz	C <sub>j</sub>	15						pF			
Maximum Reverse Recovery Time <sup>(1)</sup>	t <sub>rr</sub>	35						ns			
Typical Thermal Resistance <sup>(2)</sup>	R <sub>θJA</sub>	80						°C/W			
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150						°C			

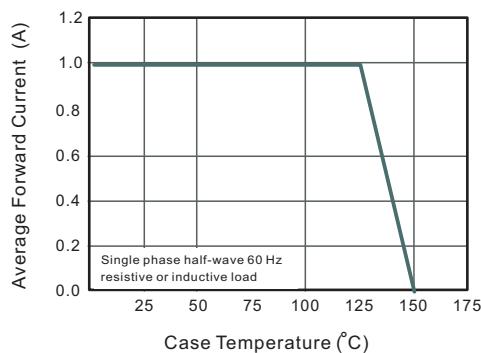
(1) Measured with I<sub>F</sub> = 0.5 A, I<sub>R</sub> = 1 A, I<sub>rr</sub> = 0.25 A

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

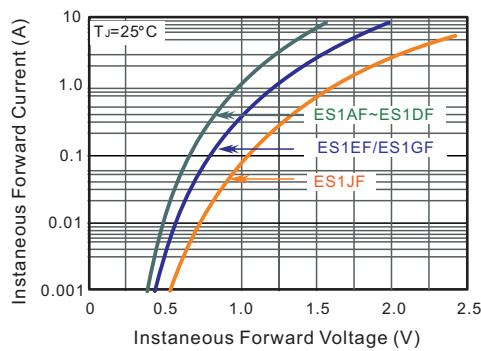
**Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram**



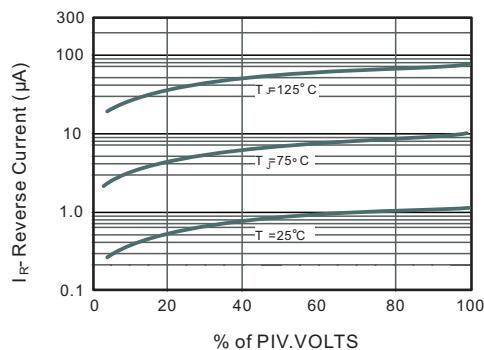
**Fig.2 Maximum Average Forward Current Rating**



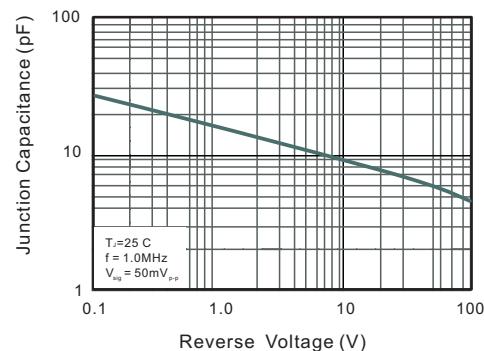
**Fig.4 Typical Forward Characteristics**



**Fig.3 Typical Reverse Characteristics**



**Fig.5 Typical Junction Capacitance**



**Fig.6 Maximum Non-Repetitive Peak Forward Surge Current**

